

Is Now Part of



### **ON Semiconductor**®

## To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.



# N-Channel Power Trench<sup>®</sup> MOSFET 25 V, 7.5 m $\Omega$

#### Features

- Max  $r_{DS(on)}$  = 7.5 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 15 A
- Max  $r_{DS(on)}$  = 11.1 m $\Omega$  at V<sub>GS</sub> = 4.5 V, I<sub>D</sub> = 12 A
- Advanced Package and Silicon combination for low r<sub>DS(on)</sub> and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

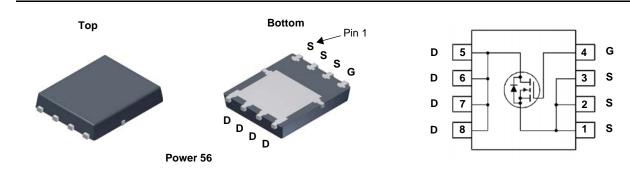


#### **General Description**

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low  $r_{DS(on)}$ , fast switching speed and body diode reverse recovery performance.

#### Applications

- Control MOSFET for Synchronous Buck Converters
- Notebook
- Server
- Telecomm
- High Efficiency DC-DC Switch Mode Power Supplies



#### MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			25	V	
V <sub>GS</sub>	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	T <sub>C</sub> = 25 °C		28		
	-Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		49		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	15	Α	
	-Pulsed			60		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	32	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		27		
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	4.6	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note	1a) 50	C/W

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity	
FDMS7580	FDMS7580	Power 56	13 "	12 mm	3000 units	

FDMS7580
N-Channel F
ower Trench
<sup>®</sup> MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V				V	
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		18		mV/°C	
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA	
On Chara	cteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	1.6	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C	
r <sub>DS(on)</sub>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		5.9	7.5		
	Static Drain to Source On Resistance	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 12 A		8.3	11.1	mΩ	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A, T <sub>J</sub> = 125 °C		8.3	10.6	7	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DD</sub> = 5 V, I <sub>D</sub> = 15 A		63		S	
C <sub>iss</sub> C <sub>oss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 13 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz		894 277 53	1190 370 80	pF pF	
C <sub>rss</sub>	-			53 1.1	80 2.2	pF	
R <sub>g</sub>	Gate Resistance			1.1	2.2	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			7.3	15	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 13 V, I <sub>D</sub> = 15 A,		2.4	10	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		17	31	ns	
t <sub>f</sub>	Fall Time			2.1	10	ns	
Q <sub>g(TOT)</sub>	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$		14	20	nC	
	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 13 V$		6.5	10	nC	
Q <sub>gs</sub>	Total Gate Charge	I <sub>D</sub> = 15 A		2.9		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			1.6		nC	
Drain-Sou	arce Diode Characteristics						
V <sub>SD</sub>		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.73	1.1	V	
▼ SD	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 15 A$ (Note 2)		0.85	1.2	v	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 15 A, di/dt = 100 A/μs		19	34	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	$r_{\rm F} = 10$ Å, u/u = 100 Å/µs		5.1	10	nC	
-							

Q<sub>rr</sub> NOTES:

t<sub>rr</sub>

1. R<sub>0,JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0,JC</sub> is guaranteed by design while R<sub>0CA</sub> is determined by the user's board design.

 $I_F = 15 \text{ A}, \text{ di/dt} = 300 \text{ A/}\mu\text{s}$ 



Reverse Recovery Time

Reverse Recovery Charge

a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

b.125 °C/W when mounted on a minimum pad of 2 oz copper

15

8.9

27

18

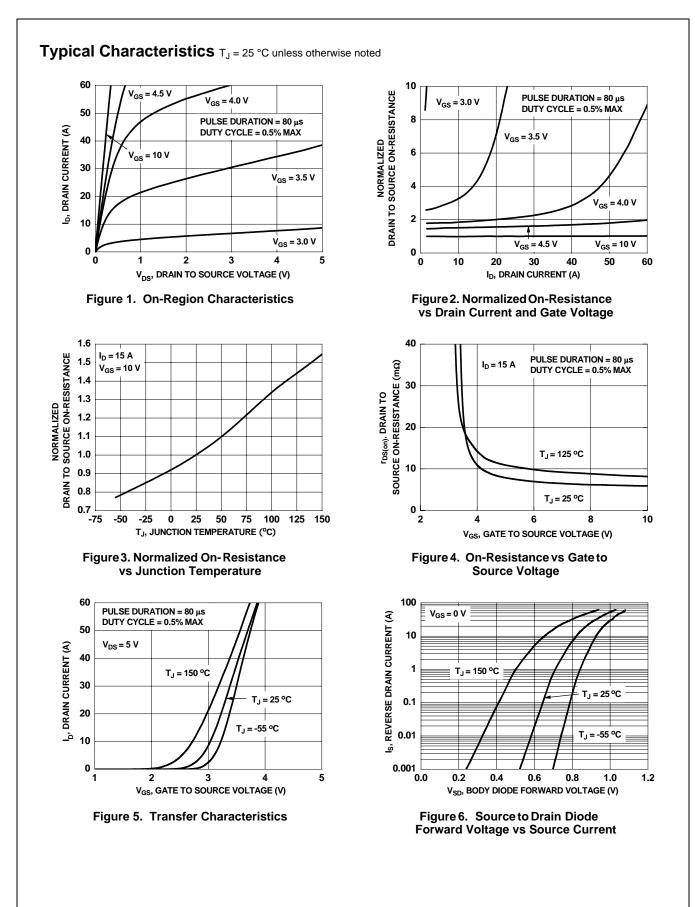
ns



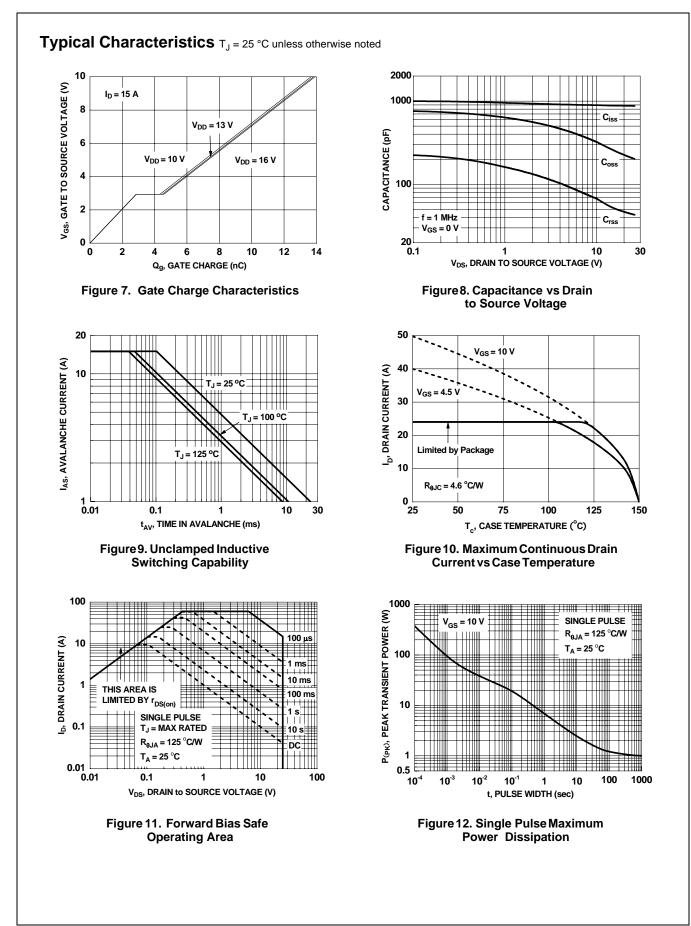
2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0 %.

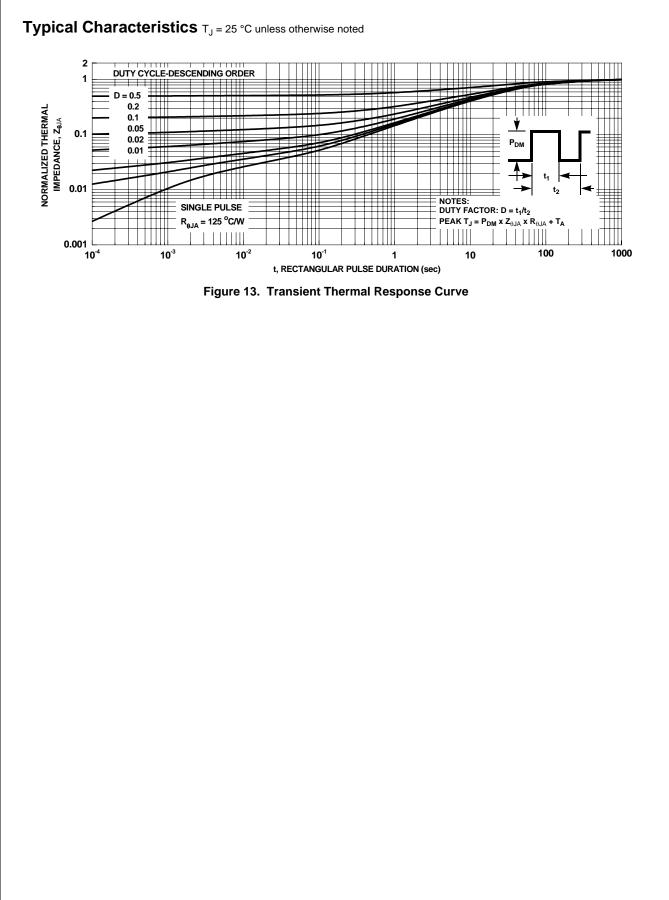
3.  $E_{AS}$  of 32 mJ is based on starting  $T_J$  = 25 °C, L = 1 mH,  $I_{AS}$  = 8 A,  $V_{DD}$  = 23 V,  $V_{GS}$  = 10 V. 100% test at L = 0.3 mH,  $I_{AS}$  = 12 A.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

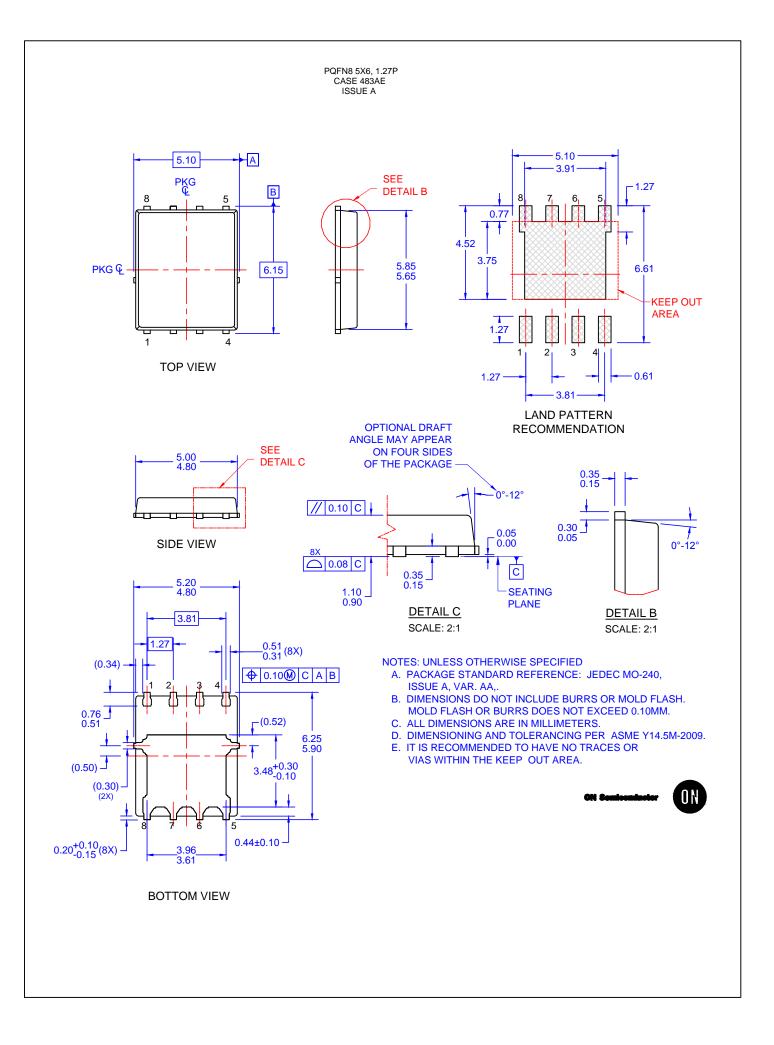








FDMS7580 N-Channel Power Trench<sup>®</sup> MOSFET



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

### **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor: FDMS7580